

100310 Low Skew 2:8 Differential Clock Driver

General Description

The 100310 is a low skew 8-bit differential clock driver which is designed to select between two separate differential clock inputs. The low output to output skew (< 50 ps) is maintained for either clock input. A LOW on the select pin (SEL) selects CLKINA, $\overline{\text{CLKINA}}$ and a HIGH on the SEL pin selects the CLKINB, $\overline{\text{CLKINB}}$ inputs.

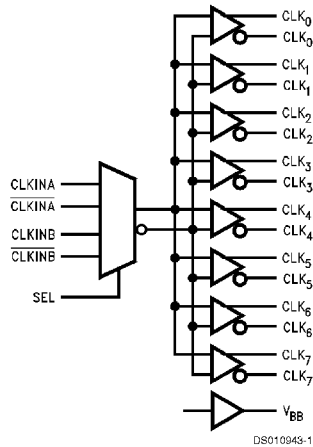
The 100310 is ideal for those applications that need the ability to freely select between two clocks, or to maintain the ability to switch to an alternate or backup clock should a problem arise with the primary clock source.

A V_{BB} output is provided for single-ended operation.

Features

- Low output to output skew
- Differential inputs and outputs
- Allows multiplexing between two clock inputs
- Voltage compensated operating range: -4.2V to -5.7V

Ordering Code: Logic Symbol

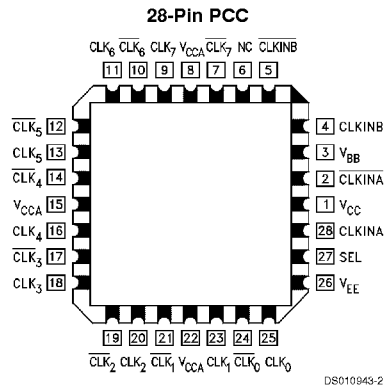


Pin Names	Description
CLKIN _n , $\overline{\text{CLKIN}}_n$	Differential Clock Inputs
SEL	Select
CLK ₀₋₇ , $\overline{\text{CLK}}_{0-8}$	Differential Clock Outputs
V_{BB}	V_{BB} Output
NC	No Connect

Truth Table

CLKINA	$\overline{\text{CLKINA}}$	CLKINB	$\overline{\text{CLKINB}}$	SEL	CLK _n	$\overline{\text{CLK}}_n$
H	L	X	X	L	H	L
L	H	X	X	L	L	H
X	X	H	L	H	H	L
X	X	L	H	H	L	H

Connection Diagram



Absolute Maximum Ratings (Note 1)

Above which the useful life may be impaired	
Storage Temperature (T_{STG})	-65°C to +150°C
Maximum Junction Temperature (T_J)	
Plastic	+150°C
Pin Potential to Ground Pin (V_{EE})	-7.0V to +0.5V
Input Voltage (DC)	V_{EE} to +0.5V
Output Current (DC Output HIGH)	-50 mA
ESD (Note 2)	≥2000V

Recommended Operating Conditions

Case Temperature (T_C)	
Commercial	0°C to +85°C
Industrial	-40°C to +85°C
Supply Voltage (V_{EE})	-5.7V to -4.2V

Note 1: Absolute maximum ratings are those values beyond which the device may be damaged or have its useful life impaired. Functional operation under these conditions is not implied.

Note 2: ESD testing conforms to MIL-STD-883, Method 3015.

Commercial Version DC Electrical Characteristics

$V_{EE} = -4.2V$ to $-5.7V$, $V_{CC} = V_{CCA} = GND$, $T_C = 0^\circ C$ to $+85^\circ C$ (Note 3)

Symbol	Parameter	Min	Typ	Max	Units	Conditions	
V_{OH}	Output HIGH Voltage	-1025	-955	-870	mV	$V_{IN} = V_{IH}$ (Max) or V_{IL} (Min)	Loading with 50Ω to -2.0V
V_{OL}	Output LOW Voltage	-1830	-1705	-1620	mV		
V_{OHC}	Output HIGH Voltage	-1035			mV	$V_{IN} = V_{IH}$ or V_{IL} (Max)	Loading with 50Ω to -2.0V
V_{OLC}	Output LOW Voltage			-1610	mV		
V_{BB}	Output Reference Voltage	-1380	-1320	-1260	mV	$I_{VBB} = -250 \mu A$	
V_{DIFF}	Input Voltage Differential	150			mV	Required for Full Output Swing	
V_{CM}	Common Mode Voltage	$V_{CC} - 2.0$		$V_{CC} - 0.5$	V		
V_{IH}	Input High Voltage	-1165		-870	mV	Guaranteed HIGH Signal for All Inputs	
V_{IL}	Input Low Voltage	-1830		-1475	mV	Guaranteed LOW Signal for All Inputs	
I_{IL}	Input LOW Current	0.50			μA	$V_{IN} = V_{IL}$ (Min)	
I_{IH}	Input HIGH Current			240	μA	$V_{IN} = V_{IH}$ (Max)	
I_{CBO}	Input Leakage Current	-10			μA	$V_{IN} = V_{EE}$	
I_{EE}	Power Supply Current	-100		-40	mA	Inputs Open	

Note 3: The specified limits represent the "worst case" value for the parameter. Since these values normally occur at the temperature extremes, additional noise immunity and guardbanding can be achieved by decreasing the allowable system operating ranges. Conditions for testing shown in the tables are chosen to guarantee operation under "worst case" conditions.

AC Electrical Characteristics

$V_{EE} = -4.2V$ to $-5.7V$, $V_{CC} = V_{CCA} = GND$

Symbol	Parameter	$T_C = 0^\circ C$			$T_C = +25^\circ C$			$T_C = +85^\circ C$			Units	Conditions
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max		
f_{MAX}	Max Toggle Frequency											
	CLKIN A/B to Q_n	750			750			750			MHz	
	SEL to Q_n	575			575			575			MHz	
t_{PLH}	Propagation Delay,											
t_{PHL}	CLKIN _n to CLK _n											
	Differential	0.80	0.90	1.00	0.82	0.92	1.02	0.89	1.01	1.09	ns	Figure 3
	Single-Ended	0.80	0.96	1.20	0.82	0.98	1.22	0.89	1.06	1.29		
t_{PLH}	Propagation Delay,	0.75	0.99	1.20	0.80	1.02	1.25	0.85	1.10	1.35	ns	Figure 2
t_{PHL}	SEL to Output											
t_{PS}	LH-HL Skew		10	30		10	30		10	30		(Notes 4, 7)
t_{OSLH}	Gate-Gate Skew LH		20	30		20	50		20	50		(Notes 5, 7)
t_{OSHL}	Gate-Gate Skew HL		20	50		20	50		20	50		(Notes 5, 7)
t_{OST}	Gate-Gate LH-HL Skew		30	60		30	60		30	60		(Notes 6, 7)
t_s	Setup Time	300			300			300			ps	
	SEL to CLKIN _n											

AC Electrical Characteristics (Continued)

$V_{EE} = -4.2V$ to $-5.7V$, $V_{CC} = V_{CCA} = GND$

Symbol	Parameter	$T_C = 0^\circ C$			$T_C = +25^\circ C$			$T_C = +85^\circ C$			Units	Conditions
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max		
t_H	Setup Time SEL to CLKIN _n	0			0			0			ps	
t_{TLH}	Transition Time	275	510	750	275	500	750	275	480	750	ps	Figure 4
t_{THL}	20% to 80%, 80% to 20%											

Note 4: t_{ps} describes opposite edge skews, i.e. the difference between the delay of a differential output signal pair's low to high and high to low propagation delays. With differential signal pairs, a low to high or high to low transition is defined as the transition of the true output or input pin.

Note 5: t_{OSLH} describes in-phase gate-to-gate differential propagation skews with all differential outputs going low to high; t_{OSHL} describes the same conditions except with the outputs going high to low.

Note 6: t_{OST} describes the maximum worst case difference in any of the t_{ps} , t_{OSLH} or t_{OST} delay paths combined.

Note 7: The skew specifications pertain to differential I/O paths.

Industrial Version DC Electrical Characteristics

$V_{EE} = -4.2V$ to $-5.7V$, $V_{CC} = V_{CCA} = GND$ (Note 8)

Symbol	Parameter	$T_C = -40^\circ C$		$T_C = 0^\circ C$ to $+85^\circ C$		Units	Conditions	
		Min	Max	Min	Max			
V_{OH}	Output HIGH Voltage	-1085	-870	-1025	-870	mV	$V_{IN} = V_{IH}$ (Max) or V_{IL} (Min)	Loading with 50 Ω to -2.0V
V_{OL}	Output LOW Voltage	-1830	-1575	-1830	-1620	mV		
V_{OHC}	Output HIGH Voltage	-1095		-1035		mV	$V_{IN} = V_{IH}$ or V_{IL} (Min)	Loading with 50 Ω to -2.0V
V_{OLC}	Output LOW Voltage		-1565		-1610	mV		
V_{BB}	Output Reference Voltage	-1395	-1255	-1380	-1260	mV	$I_{VBB} = -250 \mu A$	
V_{DIFF}	Input Voltage Differential	150		150		mV	Required for Full Output Swing	
V_{CM}	Common Mode Voltage	$V_{CC} - 2.0$	$V_{CC} - 0.5$	$V_{CC} - 2.0$	$V_{CC} - 0.5$	V		
V_{IH}	Input High Voltage	-1170	-870	-1165	-870	mV	Guaranteed HIGH Signal for All Inputs	
V_{IL}	Input Low Voltage	-1830	-1480	-1830	-1475	mV	Guaranteed LOW Signal for All Inputs	
I_{IL}	Input LOW Current	0.50		0.50		μA	$V_{IN} = V_{IL}$ (Min)	
I_{IH}	Input HIGH Current		240		240	μA	$V_{IN} = V_{IH}$ (Max)	
I_{CBO}	Input Leakage Current	-10		-10		μA	$V_{IN} = V_{EE}$	
I_{EE}	Power Supply Current	-100	-40	-100	-40	mA	Inputs Open	

Note 8: The specified limits represent the "worst case" value for the parameter. Since these values normally occur at the temperature extremes, additional noise immunity and guardbanding can be achieved by decreasing the allowable system operating ranges. Conditions for testing shown in the tables are chosen to guarantee operation under "worst case" conditions.

AC Electrical Characteristics

$V_{EE} = -4.2V$ to $-5.7V$, $V_{CC} = V_{CCA} = GND$

Symbol	Parameter	$T_C = -40^\circ C$			$T_C = +25^\circ C$			$T_C = +85^\circ C$			Units	Conditions
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max		
f_{MAX}	Max Toggle Frequency											
	CLKIN A/B to Q_n	750			750			750			MHz	
	SEL to Q_n	575			575			575			MHz	
t_{PLH}	Propagation Delay, CLKIN _n to CLK _n											
t_{PHL}	Differential	0.78	0.88	0.98	0.82	0.92	1.02	0.89	1.01	1.09	ns	Figure 3
	Single-Ended	0.78	0.95	1.18	0.82	0.98	1.22	0.89	1.06	1.29		
t_{PLH}	Propagation Delay	0.70 0.99 1.20			0.80 1.02 1.25			0.85 1.10 1.35			ns	Figure 2
t_{PHL}	SEL to Output											
t_{PS}	LH-HL Skew	10 30			10 30			10 30			ps	(Notes 4, 7)
t_{OSLH}	Gate-Gate Skew LH	20 50			20 50			20 50			ps	(Notes 5, 7)
t_{OSHL}	Gate-Gate Skew HL	20 50			20 50			20 50			ps	(Notes 5, 7)
t_{OST}	Gate-Gate LH-HL Skew	30 60			30 60			30 60			ps	(Notes 6, 7)
t_s	Setup Time SEL to CLKIN _n	300			300			300			ps	
t_H	Setup Time SEL to CLKIN _n	0			0			0			ps	
t_{TLH}	Transition Time	275	510	750	275	500	750	275	480	750	ps	Figure 4
t_{THL}	20% to 80%, 80% to 20%											

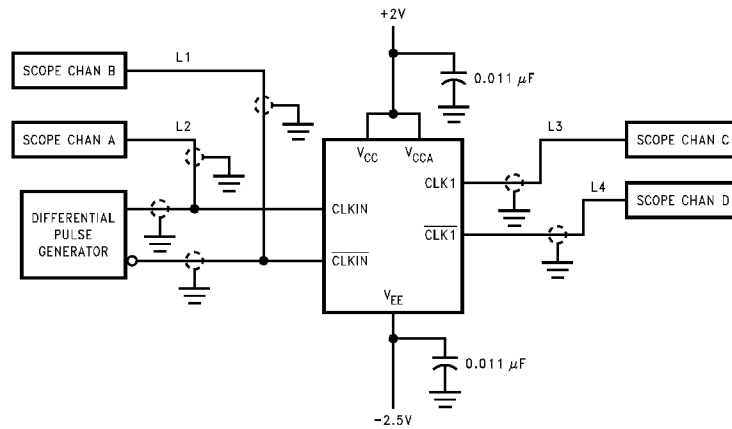
Note 9: t_{PS} describes opposite edge skews, i.e. the difference between the delay of a differential output signal pair's low to high and high to low propagation delays. With differential signal pairs, a low to high or high to low transition is defined as the transition of the true output or input pin.

Note 10: t_{OSLH} describes in-phase gate-to-gate differential propagation skews with all differential outputs going low to high; t_{OSHL} describes the same conditions except with the outputs going high to low.

Note 11: t_{OST} describes the maximum worst case difference in any of the t_{PS} , t_{OSLH} or t_{OST} delay paths combined.

Note 12: The skew specifications pertain to differential I/O paths.

Test Circuit



Note 13: Shown for testing CLKIN to CLK1 in the differential mode.

Note 14: L1, L2, L3 and L4 = equal length 50Ω impedance lines.

Note 15: All unused inputs and outputs are loaded with 50Ω in parallel with ≤ 3 pF to GND.

Note 16: Scope should have 50Ω input terminator internally.

FIGURE 1. AC Test Circuit

Switching Waveforms

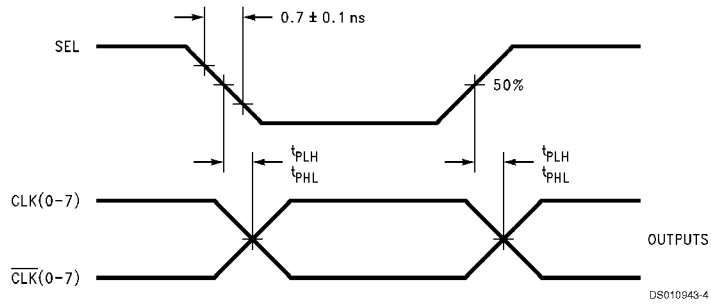


FIGURE 2. Propagation Delay, SEL to Outputs

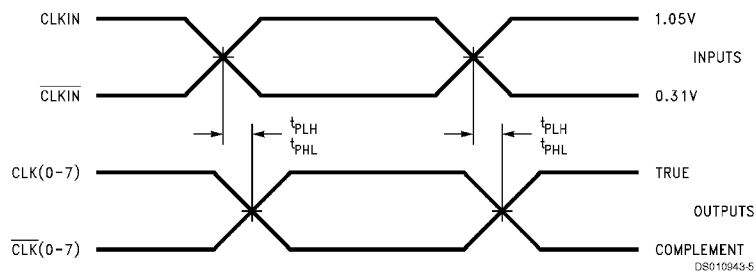


FIGURE 3. Propagation Delay, CLKIN/ $\overline{\text{CLKIN}}$ to Outputs

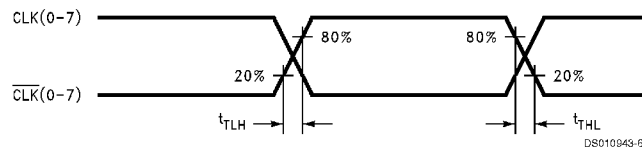
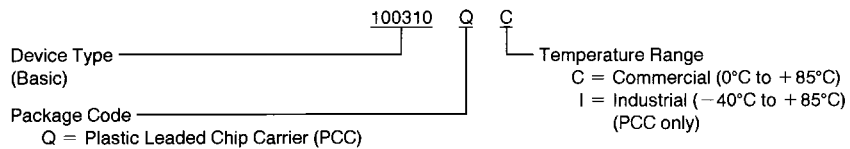


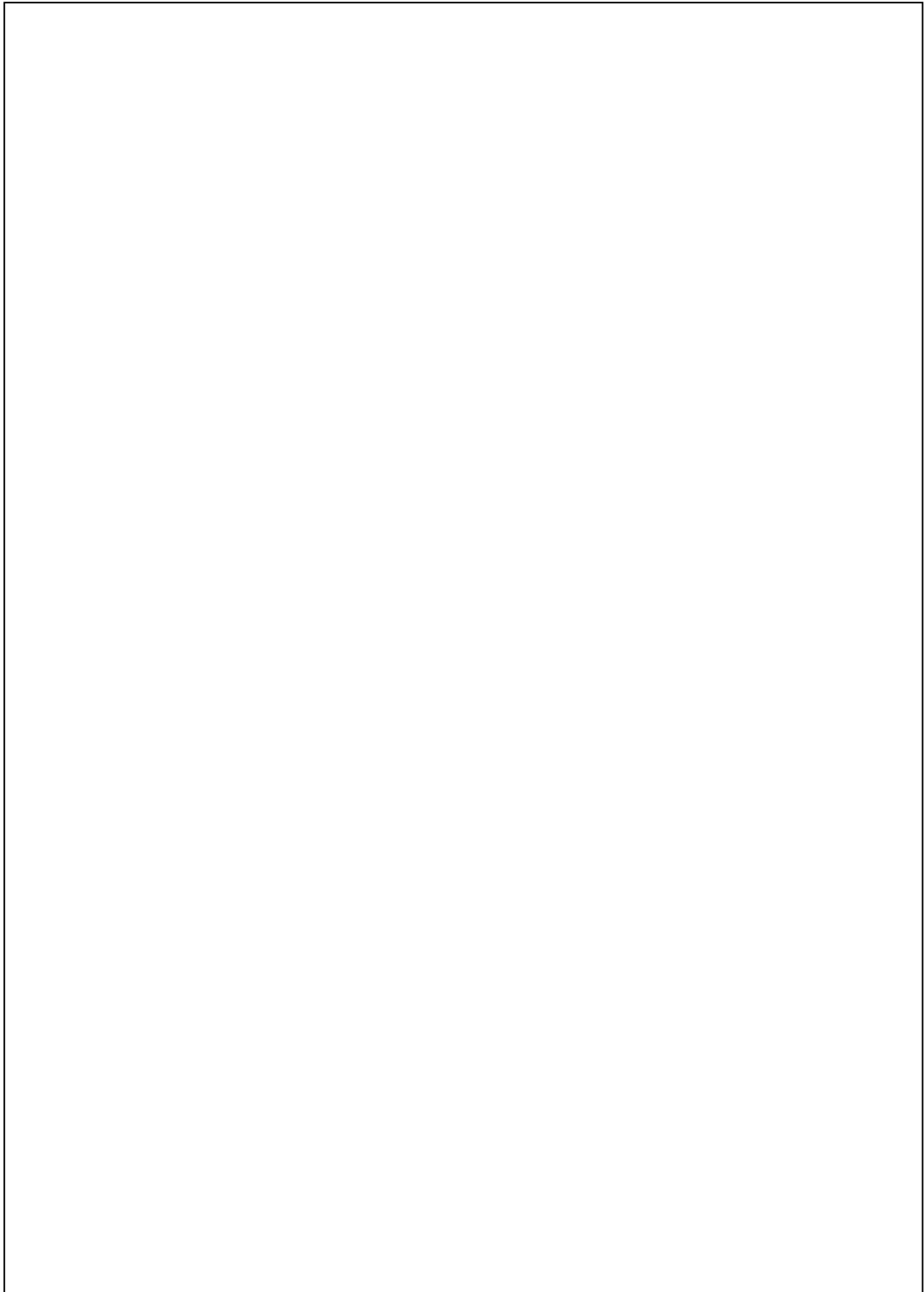
FIGURE 4. Transition Times

Ordering Information

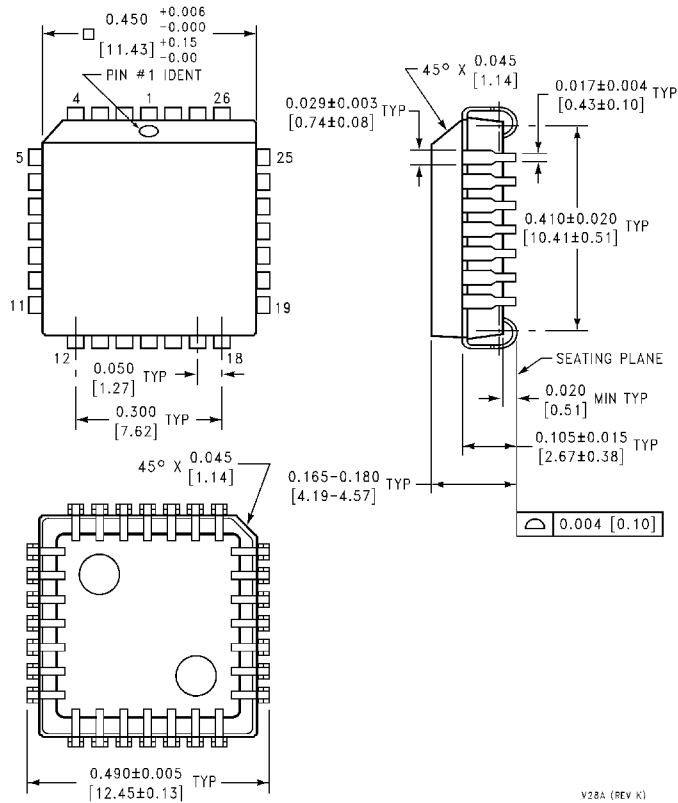
The device number is used to form part of a simplified purchasing code where a package type and temperature range are defined as follows:



DS010943-7



Physical Dimensions inches (millimeters) unless otherwise noted



**28-Lead Plastic Chip Carrier (Q)
Package Number V28A**

V28A (REV K)

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Fairchild Semiconductor Corporation
Americas
Customer Response Center
Tel: 1-888-522-5372

Fairchild Semiconductor Europe
Fax: +49 (0) 1 80-530 85 86
Email: europe.support@nsc.com
Deutsch Tel: +49 (0) 8 141-35-0
English Tel: +44 (0) 1 793-85-68-56
Italy Tel: +39 (0) 2 57 5631

Fairchild Semiconductor Hong Kong Ltd.
13th Floor, Straight Block,
Ocean Centre, 5 Canton Rd.
Tsimshatsui, Kowloon
Hong Kong
Tel: +852 2737-7200
Fax: +852 2314-0061

National Semiconductor Japan Ltd.
Tel: 81-3-5620-6175
Fax: 81-3-5620-6179

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